

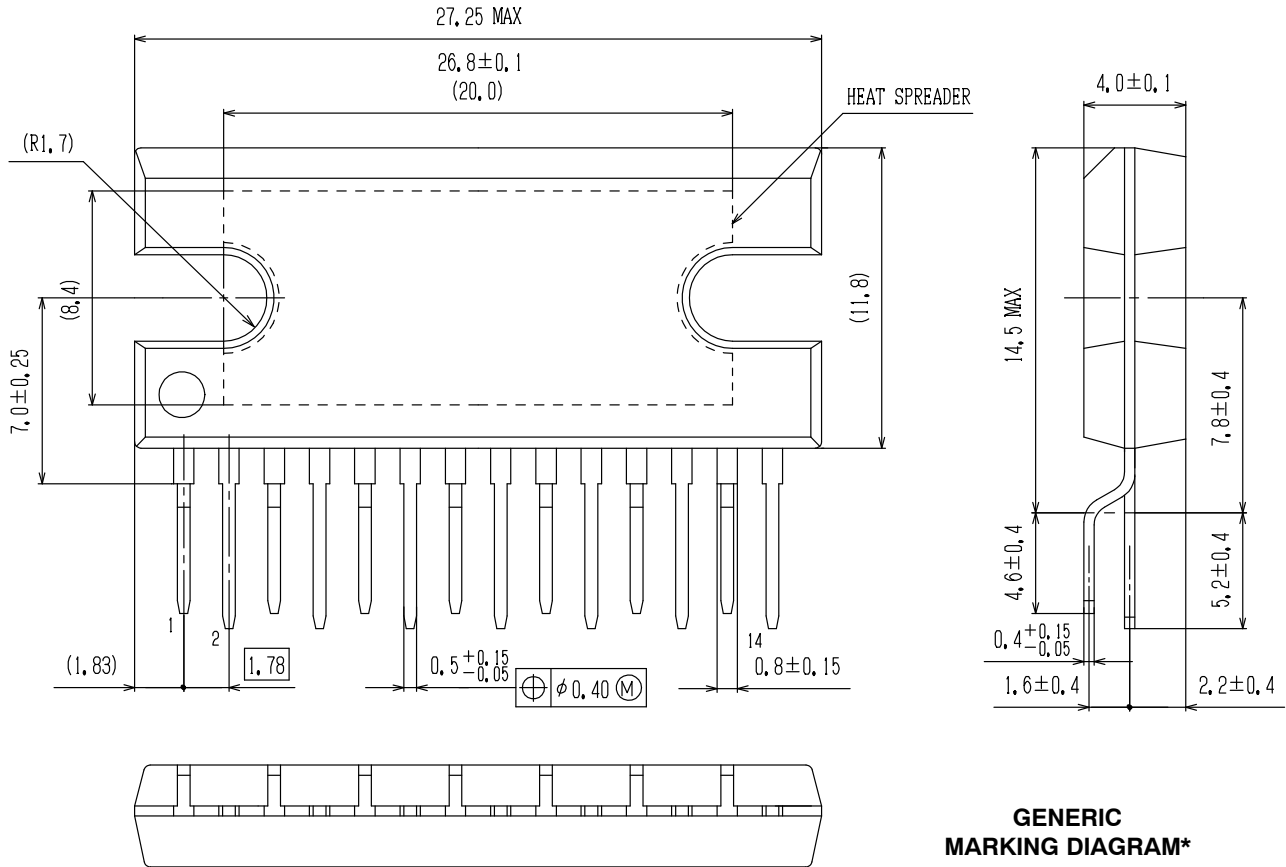
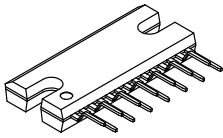
**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

ON Semiconductor®

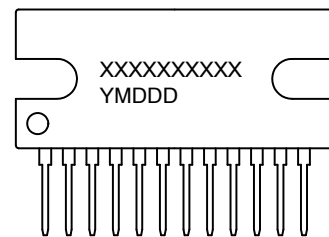


**SIP14 26.8x11.8 / SIP14HZ**  
**CASE 127AR**  
**ISSUE A**

DATE 23 OCT 2013



**GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code  
 Y = Year  
 M = Month  
 DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present.

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<b>STATUS:</b>	<b>ON SEMICONDUCTOR STANDARD</b>	
<b>NEW STANDARD:</b>		
<b>DESCRIPTION:</b>	<b>SIP14 / SIP14HZ 26.8X11.8</b>	<b>PAGE 1 OF 2</b>

